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# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Robert H. Havemann      Docket No.: TI-27506  
Serial No.: 10/001,472      Examiner: Wojciechowicz, E.  
Filed: 11/01/01      Art Unit: 2815  
For: INTEGRATED CIRCUIT HAVING A DOPED POROUS DIELECTRIC AND  
METHOD OF MANUFACTURING THE SAME

## CERTIFICATION OF FACSIMILE TRANSMISSION

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<input type="checkbox"/> CONTINUATION APP'N (# Pages)	
<input type="checkbox"/> DIVISIONAL APP'N	
NAME OF INVENTOR(S): Havemann	
TITLE OF INVENTION: Integrated Circuit Having a Doped Porous ...	
FILE NO.: TI-27506	DEPOSIT ACCT. NO.: 20-0668
FAXED: December 13, 2002 DUE: 10/17/2002 ATTY/SECY: JG	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/001,472 Filing Date: 11/01/2001	

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